



## Material Content Data Sheet



<b>Sales Product Name</b>		IPL60R360P6S		<b>Issued</b>		19. July 2018			
<b>MA#</b>		MA001590544							
<b>Package</b>		PG-TSON-8-2		<b>Weight*</b>		93.83 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	5.001	5.33	5.33	53296	53296	
leadframe	inorganic material	phosphorus	7723-14-0	0.010	0.01		109		
	non noble metal	zinc	7440-66-6	0.041	0.04		436		
	non noble metal	iron	7439-89-6	0.818	0.87		8718		
wire	non noble metal	copper	7440-50-8	33.217	35.40	36.32	353994	363257	
	non noble metal	copper	7440-50-8	0.409	0.44	0.44	4362	4362	
	encapsulation	organic material	carbon black	1333-86-4	0.098	0.10		1045	
	plastics	epoxy resin	-	5.051	5.38		53834		
	inorganic material	silicondioxide	60676-86-0	43.893	46.79	52.27	467777	522656	
leadfinish	non noble metal	tin	7440-31-5	1.053	1.12	1.12	11224	11224	
plating	noble metal	silver	7440-22-4	0.209	0.22	0.22	2224	2224	
solder	non noble metal	tin	7440-31-5	0.081	0.09		860		
	noble metal	silver	7440-22-4	0.101	0.11		1075		
	non noble metal	lead	7439-92-1	3.852	4.10	4.30	41046	42981	
*deviation	< 10%					Sum in total:	100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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